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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Active
Core Processor	HCS12
Core Size	16-Bit
Speed	25MHz
Connectivity	CANbus, I <sup>2</sup> C, SCI, SPI
Peripherals	PWM, WDT
Number of I/O	91
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	2K x 8
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2.35V ~ 5.25V
Data Converters	A/D 16x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	112-LQFP
Supplier Device Package	112-LQFP (20x20)
Purchase URL	<a href="https://www.e-xfl.com/pro/item?MUrl=&amp;PartUrl=mc9s12dt128cpv">https://www.e-xfl.com/pro/item?MUrl=&amp;PartUrl=mc9s12dt128cpv</a>

# Section 1 Introduction

## 1.1 Overview

The MC9S12DT128B microcontroller unit (MCU) is a 16-bit device composed of standard on-chip peripherals including a 16-bit central processing unit (HCS12 CPU), 128K bytes of Flash EEPROM, 8K bytes of RAM, 2K bytes of EEPROM, two asynchronous serial communications interfaces (SCI), two serial peripheral interfaces (SPI), an 8-channel IC/OC enhanced capture timer, two 8-channel, 10-bit analog-to-digital converters (ADC), an 8-channel pulse-width modulator (PWM), a digital Byte Data Link Controller (BDLC), 29 discrete digital I/O channels (Port A, Port B, Port K and Port E), 20 discrete digital I/O lines with interrupt and wakeup capability, three CAN 2.0 A, B software compatible modules (MSCAN12), a Byteflight module and an Inter-IC Bus. The MC9S12DT128B has full 16-bit data paths throughout. However, the external bus can operate in an 8-bit narrow mode so single 8-bit wide memory can be interfaced for lower cost systems. The inclusion of a PLL circuit allows power consumption and performance to be adjusted to suit operational requirements.

## 1.2 Features

- HCS12 Core
  - 16-bit HCS12 CPU
    - i. Upward compatible with M68HC11 instruction set
    - ii. Interrupt stacking and programmer's model identical to M68HC11
    - iii. 20-bit ALU
    - iv. Instruction queue
    - v. Enhanced indexed addressing
  - MEBI (Multiplexed External Bus Interface)
  - MMC (Module Mapping Control)
  - INT (Interrupt control)
  - BKP (Breakpoints)
  - BDM (Background Debug Mode)
- CRG (Clock and Reset Generator)
  - Choice of low current Colpitts oscillator or standard Pierce Oscillator
  - PLL
  - COP watchdog
  - real time interrupt
  - clock monitor
- 8-bit and 4-bit ports with interrupt functionality

**\$00E8 - \$00EF**

**BDLC (Byte Level Data Link Controller J1850)**

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$00E8	DLCBCR1	Read:	IMSG	CLKS	0	0	0	0	IE	WCM
		Write:								
\$00E9	DLCBSVR	Read:	0	0	I3	I2	I1	I0	0	0
		Write:								
\$00EA	DLCBCR2	Read:	SMRST	DLOOP	RX4XE	NBFS	TEOD	TSIFR	TMIFR1	TMIFR0
		Write:								
\$00EB	DLCBDR	Read:	D7	D6	D5	D4	D3	D2	D1	D0
		Write:								
\$00EC	DLCBARD	Read:	0	RXPOL	0	0	BO3	BO2	BO1	BO0
		Write:								
\$00ED	DLCBRSR	Read:	0	0	R5	R4	R3	R2	R1	R0
		Write:								
\$00EE	DLCSCR	Read:	0	0	0	BDLCE	0	0	0	0
		Write:								
\$00EF	DLCBSTAT	Read:	0	0	0	0	0	0	0	IDLE
		Write:								

**\$00F0 - \$00F7**

**SPI1 (Serial Peripheral Interface)**

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$00F0	SPI1CR1	Read:	SPIE	SPE	SPTIE	MSTR	CPOL	CPHA	SSOE	LSBFE
		Write:								
\$00F1	SPI1CR2	Read:	0	0	0	MODFEN	BIDIROE	0	SPISWAI	SPC0
		Write:								
\$00F2	SPI1BR	Read:	0	SPPR2	SPPR1	SPPR0	0	SPR2	SPR1	SPR0
		Write:								
\$00F3	SPI1SR	Read:	SPIF	0	SPTEF	MODF	0	0	0	0
		Write:								
\$00F4	Reserved	Read:	0	0	0	0	0	0	0	0
		Write:								
\$00F5	SPI1DR	Read:	Bit7	6	5	4	3	2	1	Bit0
		Write:								
\$00F6	Reserved	Read:	0	0	0	0	0	0	0	0
		Write:								
\$00F7	Reserved	Read:	0	0	0	0	0	0	0	0
		Write:								

**\$00F8 - \$00FF**

**Reserved**

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$00F8 - \$00FF	Reserved	Read:	0	0	0	0	0	0	0	0
		Write:								

**\$0110 - \$011B**

**EEPROM Control Register (eets2k)**

Address	Name	Read:	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$0119	EADDRLO	Read:	Bit 7	6	5	4	3	2	1	Bit 0
		Write:								
\$011A	EDATAHI	Read:	Bit 15	14	13	12	11	10	9	Bit 8
		Write:								
\$011B	EDATALO	Read:	Bit 7	6	5	4	3	2	1	Bit 0
		Write:								

**\$011C - \$011F**

**Reserved for RAM Control Register**

Address	Name	Read:	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$011C - \$011F	Reserved	Read:	0	0	0	0	0	0	0	0
		Write:								

**\$0120 - \$013F**

**ATD1 (Analog to Digital Converter 10 Bit 8 Channel)**

Address	Name	Read:	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$0120	ATD1CTL0	Read:	0	0	0	0	0	0	0	0
		Write:								
\$0121	ATD1CTL1	Read:	0	0	0	0	0	0	0	0
		Write:								
\$0122	ATD1CTL2	Read:	ADPU	AFFC	AWAI	ETRIGLE	ETRIGP	ETRIG	ASCIE	ASCIF
		Write:								
\$0123	ATD1CTL3	Read:	0	S8C	S4C	S2C	S1C	FIFO	FRZ1	FRZ0
		Write:								
\$0124	ATD1CTL4	Read:	SRES8	SMP1	SMP0	PRS4	PRS3	PRS2	PRS1	PRS0
		Write:								
\$0125	ATD1CTL5	Read:	DJM	DSGN	SCAN	MULT	0	CC	CB	CA
		Write:								
\$0126	ATD1STAT0	Read:	SCF	0	ETORF	FIFOR	0	CC2	CC1	CC0
		Write:								
\$0127	Reserved	Read:	0	0	0	0	0	0	0	0
		Write:								
\$0128	ATD1TEST0	Read:	0	0	0	0	0	0	0	0
		Write:								
\$0129	ATD1TEST1	Read:	0	0	0	0	0	0	0	SC
		Write:								
\$012A	Reserved	Read:	0	0	0	0	0	0	0	0
		Write:								
\$012B	ATD1STAT1	Read:	CCF7	CCF6	CCF5	CCF4	CCF3	CCF2	CCF1	CCF0
		Write:								
\$012C	Reserved	Read:	0	0	0	0	0	0	0	0
		Write:								
\$012D	ATD1DIEN	Read:	Bit 7	6	5	4	3	2	1	Bit 0
		Write:								
\$012E	Reserved	Read:	0	0	0	0	0	0	0	0
		Write:								
\$012F	PORTAD1	Read:	Bit7	6	5	4	3	2	1	BIT 0
		Write:								

**\$0180 - \$01BF**

**CAN1 (Motorola Scalable CAN - MSCAN)**

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$0185	CAN1RIER	Read:	WUPIE	CSCIE	RSTATE1	RSTATE0	TSTATE1	TSTATE0	OVRIE	RXFIE
		Write:								
\$0186	CAN1TFLG	Read:	0	0	0	0	0	TXE2	TXE1	TXE0
		Write:								
\$0187	CAN1TIER	Read:	0	0	0	0	0	TXEIE2	TXEIE1	TXEIE0
		Write:								
\$0188	CAN1TARQ	Read:	0	0	0	0	0	ABTRQ2	ABTRQ1	ABTRQ0
		Write:								
\$0189	CAN1TAAK	Read:	0	0	0	0	0	ABTAK2	ABTAK1	ABTAK0
		Write:								
\$018A	CAN1TBSEL	Read:	0	0	0	0	0	TX2	TX1	TX0
		Write:								
\$018B	CAN1IDAC	Read:	0	0	IDAM1	IDAM0	0	IDHIT2	IDHIT1	IDHIT0
		Write:								
\$018C	Reserved	Read:	0	0	0	0	0	0	0	0
		Write:								
\$018D	Reserved	Read:	0	0	0	0	0	0	0	0
		Write:								
\$018E	CAN1RXERR	Read:	RXERR7	RXERR6	RXERR5	RXERR4	RXERR3	RXERR2	RXERR1	RXERR0
		Write:								
\$018F	CAN1TXERR	Read:	TXERR7	TXERR6	TXERR5	TXERR4	TXERR3	TXERR2	TXERR1	TXERR0
		Write:								
\$0190 - \$0193	CAN1IDAR0 - CAN1IDAR3	Read:	AC7	AC6	AC5	AC4	AC3	AC2	AC1	AC0
		Write:								
\$0194 - \$0197	CAN1IDMR0 - CAN1IDMR3	Read:	AM7	AM6	AM5	AM4	AM3	AM2	AM1	AM0
		Write:								
\$0198 - \$019B	CAN1IDAR4 - CAN1IDAR7	Read:	AC7	AC6	AC5	AC4	AC3	AC2	AC1	AC0
		Write:								
\$019C - \$019F	CAN1IDMR4 - CAN1IDMR7	Read:	AM7	AM6	AM5	AM4	AM3	AM2	AM1	AM0
		Write:								
\$01A0 - \$01AF	CAN0RXFG	Read:	FOREGROUND RECEIVE BUFFER see <b>Table 1-2</b>							
		Write:								
\$01B0 - \$01BF	CAN0TXFG	Read:	FOREGROUND TRANSMIT BUFFER see <b>Table 1-2</b>							
		Write:								

**\$01C0 - \$01FF**

**Reserved**

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$01C0 - \$01FF	Reserved	Read:	0	0	0	0	0	0	0	0
		Write:								

**\$0200 - \$023F**

**Reserved**

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$020C - \$023F	Reserved	Read:	0	0	0	0	0	0	0	0
		Write:								

**\$0240 - \$027F**

**PIM (Port Integration Module)**

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$0259	PTIP	Read:	PTIP7	PTIP6	PTIP5	PTIP4	PTIP3	PTIP2	PTIP1	PTIP0
		Write:								
\$025A	DDRP	Read:	DDRP7	DDRP6	DDRP5	DDRP4	DDRP3	DDRP2	DDRP1	DDRP0
		Write:								
\$025B	RDRP	Read:	RDRP7	RDRP6	RDRP5	RDRP4	RDRP3	RDRP2	RDRP1	RDRP0
		Write:								
\$025C	PERP	Read:	PERP7	PERP6	PERP5	PERP4	PERP3	PERP2	PERP1	PERP0
		Write:								
\$025D	PPSP	Read:	PPSP7	PPSP6	PPSP5	PPSP4	PPSP3	PPSP2	PPSP1	PPSP0
		Write:								
\$025E	PIEP	Read:	PIEP7	PIEP6	PIEP5	PIEP4	PIEP3	PIEP2	PIEP1	PIEP0
		Write:								
\$025F	PIFP	Read:	PIFP7	PIFP6	PIFP5	PIFP4	PIFP3	PIFP2	PIFP1	PIFP0
		Write:								
\$0260	PTH	Read:	PTH7	PTH6	PTH5	PTH4	PTH3	PTH2	PTH1	PTH0
		Write:								
\$0261	PTIH	Read:	PTIH7	PTIH6	PTIH5	PTIH4	PTIH3	PTIH2	PTIH1	PTIH0
		Write:								
\$0262	DDRH	Read:	DDRH7	DDRH6	DDRH5	DDRH4	DDRH3	DDRH2	DDRH1	DDRH0
		Write:								
\$0263	RDRH	Read:	RDRH7	RDRH6	RDRH5	RDRH4	RDRH3	RDRH2	RDRH1	RDRH0
		Write:								
\$0264	PERH	Read:	PERH7	PERH6	PERH5	PERH4	PERH3	PERH2	PERH1	PERH0
		Write:								
\$0265	PPSH	Read:	PPSH7	PPSH6	PPSH5	PPSH4	PPSH3	PPSH2	PPSH1	PPSH0
		Write:								
\$0266	PIEH	Read:	PIEH7	PIEH6	PIEH5	PIEH4	PIEH3	PIEH2	PIEH1	PIEH0
		Write:								
\$0267	PIFH	Read:	PIFH7	PIFH6	PIFH5	PIFH4	PIFH3	PIFH2	PIFH1	PIFH0
		Write:								
\$0268	PTJ	Read:	PTJ7	PTJ6	0	0	0	0	PTJ1	PTJ0
		Write:								
\$0269	PTIJ	Read:	PTIJ7	PTIJ6	0	0	0	0	PTIJ1	PTIJ0
		Write:								
\$026A	DDRJ	Read:	DDRJ7	DDRJ6	0	0	0	0	DDRJ1	DDRJ0
		Write:								
\$026B	RDRJ	Read:	RDRJ7	RDRJ6	0	0	0	0	RDRJ1	RDRJ0
		Write:								
\$026C	PERJ	Read:	PERJ7	PERJ6	0	0	0	0	PERJ1	PERJ0
		Write:								
\$026D	PPSJ	Read:	PPSJ7	PPSJ6	0	0	0	0	PPSJ1	PPSJ0
		Write:								
\$026E	PIEJ	Read:	PIEJ7	PIEJ6	0	0	0	0	PIEJ1	PIEJ0
		Write:								
\$026F	PIFJ	Read:	PIFJ7	PIFJ6	0	0	0	0	PIFJ1	PIFJ0
		Write:								
\$0270 - \$027F	Reserved	Read:	0	0	0	0	0	0	0	0
		Write:								

Freescale Semiconductor, Inc.

**\$0280 - \$02BF**

**CAN4 (Motorola Scalable CAN - MSCAN)**

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
\$0280	CAN4CTL0	Read:	RXFRM	RXACT	CSWAI	SYNCH	TIME	WUPE	SLPRQ	INITRQ
		Write:								
\$0281	CAN4CTL1	Read:	CANE	CLKSRC	LOOPB	LISTEN	0	WUPM	SLPAK	INITAK
		Write:								
\$0282	CAN4BTR0	Read:	SJW1	SJW0	BRP5	BRP4	BRP3	BRP2	BRP1	BRP0
		Write:								
\$0283	CAN4BTR1	Read:	SAMP	TSEG22	TSEG21	TSEG20	TSEG13	TSEG12	TSEG11	TSEG10
		Write:								
\$0284	CAN4RFLG	Read:	WUPIF	CSCIF	RSTAT1	RSTAT0	TSTAT1	TSTAT0	OVRIF	RXF
		Write:								
\$0285	CAN4RIER	Read:	WUPIE	CSCIE	RSTATE1	RSTATE0	TSTATE1	TSTATE0	OVRIE	RXFIE
		Write:								
\$0286	CAN4TFLG	Read:	0	0	0	0	0	TXE2	TXE1	TXE0
		Write:								
\$0287	CAN4TIER	Read:	0	0	0	0	0	TXEIE2	TXEIE1	TXEIE0
		Write:								
\$0288	CAN4TARQ	Read:	0	0	0	0	0	ABTRQ2	ABTRQ1	ABTRQ0
		Write:								
\$0289	CAN4TAAK	Read:	0	0	0	0	0	ABTAK2	ABTAK1	ABTAK0
		Write:								
\$028A	CAN4TBSEL	Read:	0	0	0	0	0	TX2	TX1	TX0
		Write:								
\$028B	CAN4IDAC	Read:	0	0	IDAM1	IDAM0	0	IDHIT2	IDHIT1	IDHIT0
		Write:								
\$028C	Reserved	Read:	0	0	0	0	0	0	0	0
		Write:								
\$028D	Reserved	Read:	0	0	0	0	0	0	0	0
		Write:								
\$028E	CAN4RXERR	Read:	RXERR7	RXERR6	RXERR5	RXERR4	RXERR3	RXERR2	RXERR1	RXERR0
		Write:								
\$028F	CAN4TXERR	Read:	TXERR7	TXERR6	TXERR5	TXERR4	TXERR3	TXERR2	TXERR1	TXERR0
		Write:								
\$0290 - \$0293	CAN0IDAR0 - CAN0IDAR3	Read:	AC7	AC6	AC5	AC4	AC3	AC2	AC1	AC0
		Write:								
\$0294 - \$0297	CAN0IDMR0 - CAN0IDMR3	Read:	AM7	AM6	AM5	AM4	AM3	AM2	AM1	AM0
		Write:								
\$0298 - \$029B	CAN0IDAR4 - CAN0IDAR7	Read:	AC7	AC6	AC5	AC4	AC3	AC2	AC1	AC0
		Write:								
\$029C - \$029F	CAN0IDMR4 - CAN0IDMR7	Read:	AM7	AM6	AM5	AM4	AM3	AM2	AM1	AM0
		Write:								
\$02A0 - \$02AF	CAN4RXFG	Read:	FOREGROUND RECEIVE BUFFER see <b>Table 1-2</b>							
		Write:								
\$02B0 - \$02BF	CAN4TXFG	Read:	FOREGROUND TRANSMIT BUFFER see <b>Table 1-2</b>							
		Write:								

### 2.3.6 PAD[15] / AN1[7] / ETRIG1 — Port AD Input Pin [15]

PAD15 is a general purpose input pin and analog input of the analog to digital converter ATD1. It can act as an external trigger input for the ATD1.

### 2.3.7 PAD[14:8] / AN1[6:0] — Port AD Input Pins [14:8]

PAD14 - PAD8 are general purpose input pins and analog inputs of the analog to digital converter ATD1.

### 2.3.8 PAD[7] / AN0[7] / ETRIG0 — Port AD Input Pin [7]

PAD7 is a general purpose input pin and analog input of the analog to digital converter ATD0. It can act as an external trigger input for the ATD0.

### 2.3.9 PAD[6:0] / AN0[6:0] — Port AD Input Pins [6:0]

PAD6 - PAD0 are general purpose input pins and analog inputs of the analog to digital converter ATD0.

### 2.3.10 PA[7:0] / ADDR[15:8] / DATA[15:8] — Port A I/O Pins

PA7-PA0 are general purpose input or output pins. In MCU expanded modes of operation, these pins are used for the multiplexed external address and data bus.

### 2.3.11 PB[7:0] / ADDR[7:0] / DATA[7:0] — Port B I/O Pins

PB7-PB0 are general purpose input or output pins. In MCU expanded modes of operation, these pins are used for the multiplexed external address and data bus.

### 2.3.12 PE7 / NOACC / $\overline{XCLKS}$ — Port E I/O Pin 7

PE7 is a general purpose input or output pin. During MCU expanded modes of operation, the NOACC signal, when enabled, is used to indicate that the current bus cycle is an unused or “free” cycle. This signal will assert when the CPU is not using the bus.

The  $\overline{XCLKS}$  is an input signal which controls whether a crystal in combination with the internal Colpitts (low power) oscillator is used or whether Pierce oscillator/external clock circuitry is used. The state of this pin is latched at the rising edge of  $\overline{RESET}$ . If the input is a logic low the EXTAL pin is configured for an external clock drive. If input is a logic high an oscillator circuit is configured on EXTAL and XTAL. Since this pin is an input with a pull-up device during reset, if the pin is left floating, the default configuration is an oscillator circuit on EXTAL and XTAL.



### 2.3.13 PE6 / MODB / IPIPE1 — Port E I/O Pin 6

PE6 is a general purpose input or output pin. It is used as a MCU operating mode select pin during reset. The state of this pin is latched to the MODB bit at the rising edge of  $\overline{\text{RESET}}$ . This pin is shared with the instruction queue tracking signal IPIPE1. This pin is an input with a pull-down device which is only active when  $\overline{\text{RESET}}$  is low.

### 2.3.14 PE5 / MODA / IPIPE0 — Port E I/O Pin 5

PE5 is a general purpose input or output pin. It is used as a MCU operating mode select pin during reset. The state of this pin is latched to the MODA bit at the rising edge of  $\overline{\text{RESET}}$ . This pin is shared with the instruction queue tracking signal IPIPE0. This pin is an input with a pull-down device which is only active when  $\overline{\text{RESET}}$  is low.

### 2.3.15 PE4 / ECLK — Port E I/O Pin 4

PE4 is a general purpose input or output pin. It can be configured to drive the internal bus clock ECLK. ECLK can be used as a timing reference.

### 2.3.16 PE3 / $\overline{\text{LSTRB}}$ / $\overline{\text{TAGLO}}$ — Port E I/O Pin 3

PE3 is a general purpose input or output pin. In MCU expanded modes of operation,  $\overline{\text{LSTRB}}$  can be used for the low-byte strobe function to indicate the type of bus access and when instruction tagging is on,  $\overline{\text{TAGLO}}$  is used to tag the low half of the instruction word being read into the instruction queue.

### 2.3.17 PE2 / $\overline{\text{R/W}}$ — Port E I/O Pin 2

PE2 is a general purpose input or output pin. In MCU expanded modes of operations, this pin drives the read/write output signal for the external bus. It indicates the direction of data on the external bus.

### 2.3.18 PE1 / $\overline{\text{IRQ}}$ — Port E Input Pin 1

PE1 is a general purpose input pin and the maskable interrupt request input that provides a means of applying asynchronous interrupt requests. This will wake up the MCU from STOP or WAIT mode.

### 2.3.19 PE0 / $\overline{\text{XIRQ}}$ — Port E Input Pin 0

PE0 is a general purpose input pin and the non-maskable interrupt request input that provides a means of applying asynchronous interrupt requests. This will wake up the MCU from STOP or WAIT mode.

### 2.3.20 PH7 / KWH7 — Port H I/O Pin 7

PH7 is a general purpose input or output pin. It can be configured to generate an interrupt causing the MCU to exit STOP or WAIT mode.

### 2.3.36 PM4 / BF\_PSYN / RXCAN0 / RXCAN4/ MOSI0 — Port M I/O Pin 4

PM4 is a general purpose input or output pin. It can be configured as the correct synchronisation pulse reception/transmission output pulse pin of Byteflight. It can be configured as the receive pin RXCAN of the Motorola Scalable Controller Area Network controllers 0 or 4 (CAN0 or CAN4). It can be configured as the master output (during master mode) or slave input pin (during slave mode) MOSI for the Serial Peripheral Interface 0 (SPI0).

### 2.3.37 PM3 / TX\_BF / TXCAN1 / TXCAN0 / $\overline{SS}$ — Port M I/O Pin 3

PM3 is a general purpose input or output pin. It can be configured as the transmit pin TX\_BF of Byteflight. It can be configured as the transmit pin TXCAN of the Motorola Scalable Controller Area Network controllers 1 or 0 (CAN1 or CAN0). It can be configured as the slave select pin  $\overline{SS}$  of the Serial Peripheral Interface 0 (SPI0).

### 2.3.38 PM2 / RX\_BF / RXCAN1 / RXCAN0 / MISO0 — Port M I/O Pin 2

PM2 is a general purpose input or output pin. It can be configured as the receive pin RX\_BF of Byteflight. It can be configured as the receive pin RXCAN of the Motorola Scalable Controller Area Network controllers 1 or 0 (CAN1 or CAN0). It can be configured as the master input (during master mode) or slave output pin (during slave mode) MISO for the Serial Peripheral Interface 0 (SPI0).

### 2.3.39 PM1 / TXCAN0 / TXB — Port M I/O Pin 1

PM1 is a general purpose input or output pin. It can be configured as the transmit pin TXCAN of the Motorola Scalable Controller Area Network controller 0 (CAN0). It can be configured as the transmit pin TXB of the BDLC.

### 2.3.40 PM0 / RXCAN0 / RXB — Port M I/O Pin 0

PM0 is a general purpose input or output pin. It can be configured as the receive pin RXCAN of the Motorola Scalable Controller Area Network controller 0 (CAN0). It can be configured as the receive pin RXB of the BDLC.

### 2.3.41 PP7 / KWP7 / PWM7 — Port P I/O Pin 7

PP7 is a general purpose input or output pin. It can be configured to generate an interrupt causing the MCU to exit STOP or WAIT mode. It can be configured as Pulse Width Modulator (PWM) channel 7 output.

### 2.3.42 PP6 / KWP6 / PWM6 — Port P I/O Pin 6

PP6 is a general purpose input or output pin. It can be configured to generate an interrupt causing the MCU to exit STOP or WAIT mode. It can be configured as Pulse Width Modulator (PWM) channel 6 output.

## Section 5 Resets and Interrupts

### 5.1 Overview

Consult the Exception Processing section of the HCS12 Core User Guide for information on resets and interrupts.

### 5.2 Vectors

#### 5.2.1 Vector Table

Table 5-1 lists interrupt sources and vectors in default order of priority.

**Table 5-1 Interrupt Vector Locations**

Vector Address	Interrupt Source	CCR Mask	Local Enable	HPRIO Value to Elevate
\$FFFE, \$FFFF	Reset	None	None	–
\$FFFC, \$FFFD	Clock Monitor fail reset	None	COPCTL (CME, FCME)	–
\$FFFA, \$FFFB	COP failure reset	None	COP rate select	–
\$FFF8, \$FFF9	Unimplemented instruction trap	None	None	–
\$FFF6, \$FFF7	SWI	None	None	–
\$FFF4, \$FFF5	XIRQ / BF High prio Sync pulse intr	X-Bit	None / BFRIER (XSYNIE)	–
\$FFF2, \$FFF3	IRQ	I-Bit	INTCR (IRQEN)	\$F2
\$FFF0, \$FFF1	Real Time Interrupt	I-Bit	CRGINT (RTIE)	\$F0
\$FFEE, \$FFEF	Enhanced Capture Timer channel 0	I-Bit	TIE (C0I)	\$EE
\$FFEC, \$FFED	Enhanced Capture Timer channel 1	I-Bit	TIE (C1I)	\$EC
\$FFEA, \$FFEB	Enhanced Capture Timer channel 2	I-Bit	TIE (C2I)	\$EA
\$FFE8, \$FFE9	Enhanced Capture Timer channel 3	I-Bit	TIE (C3I)	\$E8
\$FFE6, \$FFE7	Enhanced Capture Timer channel 4	I-Bit	TIE (C4I)	\$E6
\$FFE4, \$FFE5	Enhanced Capture Timer channel 5	I-Bit	TIE (C5I)	\$E4
\$FFE2, \$FFE3	Enhanced Capture Timer channel 6	I-Bit	TIE (C6I)	\$E2
\$FFE0, \$FFE1	Enhanced Capture Timer channel 7	I-Bit	TIE (C7I)	\$E0
\$FFDE, \$FFDF	Enhanced Capture Timer overflow	I-Bit	TSCR2 (TOF)	\$DE
\$FFDC, \$FFDD	Pulse accumulator A overflow	I-Bit	PACTL (PAOVI)	\$DC
\$FFDA, \$FFDB	Pulse accumulator input edge	I-Bit	PACTL (PAI)	\$DA
\$FFD8, \$FFD9	SPI0	I-Bit	SPICR1 (SPIE, SPTIE)	\$D8
\$FFD6, \$FFD7	SCI0	I-Bit	SCICR2 (TIE, TCIE, RIE, ILIE)	\$D6
\$FFD4, \$FFD5	SCI1	I-Bit	SCICR2 (TIE, TCIE, RIE, ILIE)	\$D4
\$FFD2, \$FFD3	ATD0	I-Bit	ATDCTL2 (ASCIE)	\$D2
\$FFD0, \$FFD1	ATD1	I-Bit	ATDCTL2 (ASCIE)	\$D0
\$FFCE, \$FFCF	Port J	I-Bit	PIEJ (PIEJ7, PIEJ6, PIEJ1, PIEJ0)	\$CE
\$FFCC, \$FFCD	Port H	I-Bit	PIEH (PIEH7-0)	\$CC

\$FFCA, \$FFCB	Modulus Down Counter underflow	I-Bit	MCCTL (MCZI)	\$CA
\$FFC8, \$FFC9	Pulse Accumulator B Overflow	I-Bit	PBCTL (PBOVI)	\$C8
\$FFC6, \$FFC7	CRG PLL lock	I-Bit	PLLCR (LOCKIE)	\$C6
\$FFC4, \$FFC5	CRG Self Clock Mode	I-Bit	PLLCR (SCMIE)	\$C4
\$FFC2, \$FFC3	BDLC	I-Bit	DLCBCR1 (IE)	\$C2
\$FFC0, \$FFC1	IIC Bus	I-Bit	IBCR (IBIE)	\$C0
\$FFBE, \$FFBF	SPI1	I-Bit	SPICR1 (SPIE, SPTIE)	\$BE
\$FFBC, \$FFBD	Reserved			
\$FFBA, \$FFBB	EEPROM	I-Bit	ECNFG (CCIE, CBEIE)	\$BA
\$FFB8, \$FFB9	FLASH	I-Bit	FCNFG (CCIE, CBEIE)	\$B8
\$FFB6, \$FFB7	CAN0 wake-up	I-Bit	CANRIER (WUPIE)	\$B6
\$FFB4, \$FFB5	CAN0 errors	I-Bit	CANRIER (CSCIE, OVRIE)	\$B4
\$FFB2, \$FFB3	CAN0 receive	I-Bit	CANRIER (RXFIE)	\$B2
\$FFB0, \$FFB1	CAN0 transmit	I-Bit	CANTIER (TXEIE[2:0])	\$B0
\$FFAE, \$FFAF	CAN1 wake-up	I-Bit	CANRIER (WUPIE)	\$AE
\$FFAC, \$FFAD	CAN1 errors	I-Bit	CANRIER (CSCIE, OVRIE)	\$AC
\$FFAA, \$FFAB	CAN1 receive	I-Bit	CANRIER (RXFIE)	\$AA
\$FFA8, \$FFA9	CAN1 transmit	I-Bit	CANTIER (TXEIE[2:0])	\$A8
\$FFA6, \$FFA7	BF Rx FIFO not empty	I-Bit	BFRIER (RCVFIE)	\$A6
\$FFA4, \$FFA5	BF receive	I-Bit	BFBUFCTL[15:0] (IENA)	\$A4
\$FFA2, \$FFA3	BF Synchronisation	I-Bit	BFRIER (SYNAIE, SYNINIE)	\$A2
\$FFA0, \$FFA1	BF general	I-Bit	BFBUFCTL[15:0] (IENA), BFGIER (OVRNIE, ERRIE, SYNEIE, SYNINIE, ILLPIE, LOCKIE, WAKEIE) BFRIER (SLMMIE)	\$A0
\$FF98, \$FF9F	Reserved			
\$FF96, \$FF97	CAN4 wake-up	I-Bit	CANRIER (WUPIE)	\$96
\$FF94, \$FF95	CAN4 errors	I-Bit	CANRIER (CSCIE, OVRIE)	\$94
\$FF92, \$FF93	CAN4 receive	I-Bit	CANRIER (RXFIE)	\$92
\$FF90, \$FF91	CAN4 transmit	I-Bit	CANTIER (TXEIE[2:0])	\$90
\$FF8E, \$FF8F	Port P Interrupt	I-Bit	PIEP (PIEP7-0)	\$8E
\$FF8C, \$FF8D	PWM Emergency Shutdown	I-Bit	PWMSDN (PWMIE)	\$8C
\$FF80 to \$FF8B	Reserved			

## 5.3 Effects of Reset

When a reset occurs, MCU registers and control bits are changed to known start-up states. Refer to the respective module Block User Guides for register reset states.

### 5.3.1 I/O pins

Refer to the HCS12 Core User Guides for mode dependent pin configuration of port A, B, E and K out of reset.

Refer to the PIM Block User Guide for reset configurations of all peripheral module ports.

**NOTE:** *In the following context VDD5 is used for either VDDA, VDDR and VDDX; VSS5 is used for either VSSA, VSSR and VSSX unless otherwise noted. IDD5 denotes the sum of the currents flowing into the VDDA, VDDX and VDDR pins. VDD is used for VDD1, VDD2 and VDDPLL, VSS is used for VSS1, VSS2 and VSSPLL. IDD is used for the sum of the currents flowing into VDD1 and VDD2.*

### A.1.3 Pins

There are four groups of functional pins.

#### A.1.3.1 5V I/O pins

Those I/O pins have a nominal level of 5V. This class of pins is comprised of all port I/O pins, the analog inputs, BKGD pin and the RESET inputs. The internal structure of all those pins is identical, however some of the functionality may be disabled. E.g. for the analog inputs the output drivers, pull-up and pull-down resistors are disabled permanently.

#### A.1.3.2 Analog Reference

This class is made up by the two VRH and VRL pins.

#### A.1.3.3 Oscillator

The pins XFC, EXTAL, XTAL dedicated to the oscillator have a nominal 2.5V level. They are supplied by VDDPLL.

#### A.1.3.4 TEST

This pin is used for production testing only.

#### A.1.3.5 VREGEN

This pin is used to enable the on chip voltage regulator.

### A.1.4 Current Injection

Power supply must maintain regulation within operating  $V_{DD5}$  or  $V_{DD}$  range during instantaneous and operating maximum current conditions. If positive injection current ( $V_{in} > V_{DD5}$ ) is greater than  $I_{DD5}$ , the injection current may flow out of VDD5 and could result in external power supply going out of regulation. Insure external VDD5 load will shunt current greater than maximum injection current. This will be the greatest risk when the MCU is not consuming power; e.g. if no system clock is present, or if clock rate is very low which would reduce overall power consumption.

A device will be defined as a failure if after exposure to ESD pulses the device no longer meets the device specification. Complete DC parametric and functional testing is performed per the applicable device specification at room temperature followed by hot temperature, unless specified otherwise in the device specification.

**Table A-2 ESD and Latch-up Test Conditions**

Model	Description	Symbol	Value	Unit
Human Body	Series Resistance	R1	1500	Ohm
	Storage Capacitance	C	100	pF
	Number of Pulse per pin positive negative	–	– 3 3	
Machine	Series Resistance	R1	0	Ohm
	Storage Capacitance	C	200	pF
	Number of Pulse per pin positive negative	–	– 3 3	
Latch-up	Minimum input voltage limit		–2.5	V
	Maximum input voltage limit		7.5	V

**Table A-3 ESD and Latch-Up Protection Characteristics**

Num	C	Rating	Symbol	Min	Max	Unit
1	C	Human Body Model (HBM)	$V_{HBM}$	2000	–	V
2	C	Machine Model (MM)	$V_{MM}$	200	–	V
3	C	Charge Device Model (CDM)	$V_{CDM}$	500	–	V
4	C	Latch-up Current at 125°C positive negative	$I_{LAT}$	+100 –100	–	mA
5	C	Latch-up Current at 27°C positive negative	$I_{LAT}$	+200 –200	–	mA

### A.1.7 Operating Conditions

This chapter describes the operating conditions of the device. Unless otherwise noted those conditions apply to all the following data.

**NOTE:** Please refer to the temperature rating of the device (C, V, M) with regards to the ambient temperature  $T_A$  and the junction temperature  $T_J$ . For power dissipation

## **A.1.10 Supply Currents**

This section describes the current consumption characteristics of the device as well as the conditions for the measurements.

### **A.1.10.1 Measurement Conditions**

All measurements are without output loads. Unless otherwise noted the currents are measured in single chip mode, internal voltage regulator enabled and at 25MHz bus frequency using a 4MHz oscillator in Colpitts mode. Production testing is performed using a square wave signal at the EXTAL input.

### **A.1.10.2 Additional Remarks**

In expanded modes the currents flowing in the system are highly dependent on the load at the address, data and control signals as well as on the duty cycle of those signals. No generally applicable numbers can be

## A.6 MSCAN

Table A-17 MSCAN Wake-up Pulse Characteristics

Conditions are shown in <b>Table A-4</b> unless otherwise noted							
Num	C	Rating	Symbol	Min	Typ	Max	Unit
1	P	MSCAN Wake-up dominant pulse filtered	$t_{WUP}$			2	$\mu\text{s}$
2	P	MSCAN Wake-up dominant pulse pass	$t_{WUP}$	5			$\mu\text{s}$



**Table A-19 SPI Slave Mode Timing Characteristics**

Conditions are shown in **Table A-4** unless otherwise noted, CLOAD = 200pF on all outputs

Num	C	Rating	Symbol	Min	Typ	Max	Unit
1	P	Operating Frequency	$f_{op}$	DC		1/4	$f_{bus}$
1	P	SCK Period $t_{sck} = 1./f_{op}$	$t_{sck}$	4		2048	$t_{bus}$
2	D	Enable Lead Time	$t_{lead}$	1			$t_{cyc}$
3	D	Enable Lag Time	$t_{lag}$	1			$t_{cyc}$
4	D	Clock (SCK) High or Low Time	$t_{wsck}$	$t_{cyc} - 30$			ns
5	D	Data Setup Time (Inputs)	$t_{su}$	25			ns
6	D	Data Hold Time (Inputs)	$t_{hi}$	25			ns
7	D	Slave Access Time	$t_a$			1	$t_{cyc}$
8	D	Slave MISO Disable Time	$t_{dis}$			1	$t_{cyc}$
9	D	Data Valid (after SCK Edge)	$t_v$			25	ns
10	D	Data Hold Time (Outputs)	$t_{ho}$	0			ns
11	D	Rise Time Inputs and Outputs	$t_r$			25	ns
12	D	Fall Time Inputs and Outputs	$t_f$			25	ns

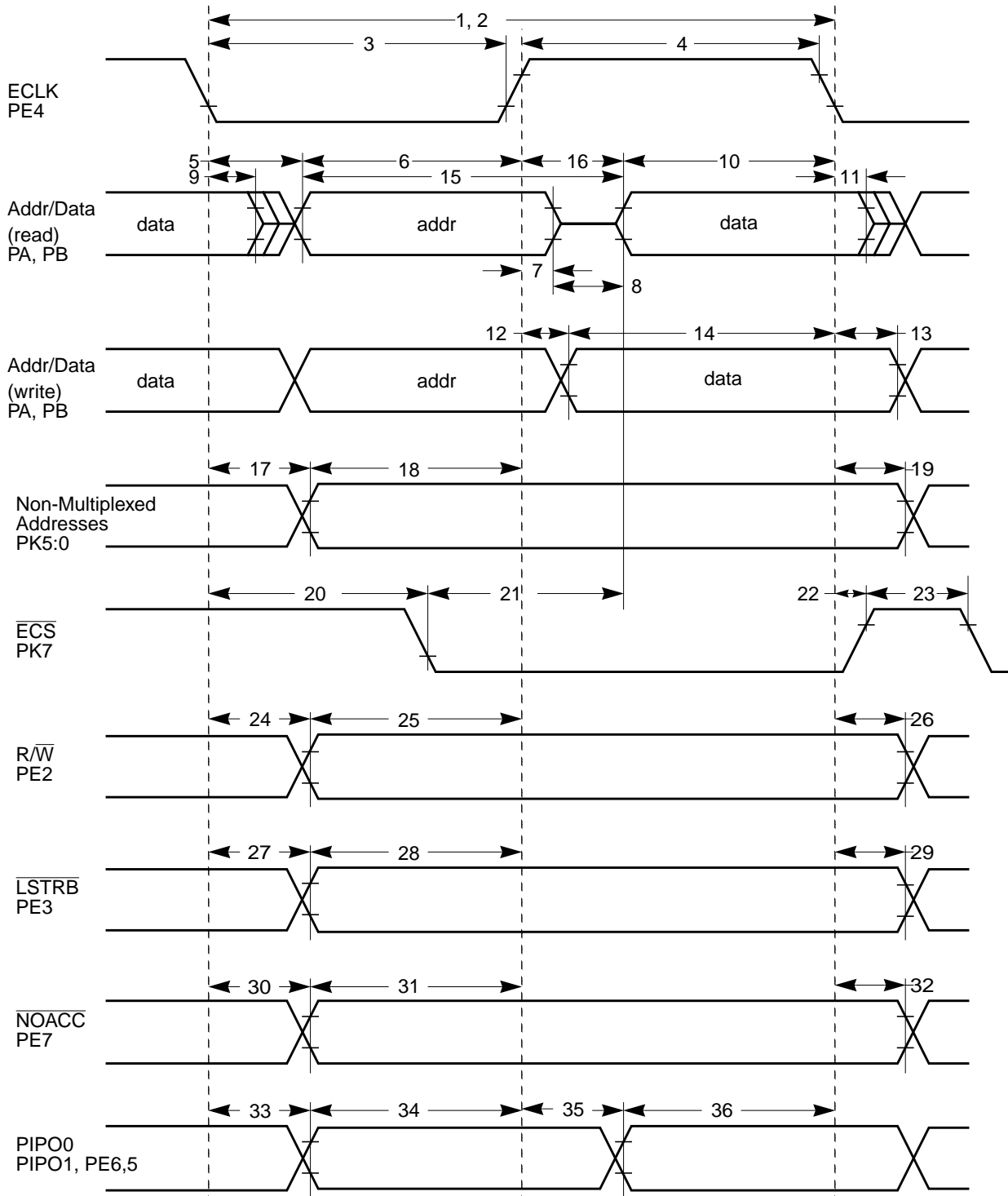
Freescale Semiconductor, Inc.

## A.8 External Bus Timing

A timing diagram of the external multiplexed-bus is illustrated in **Figure A-9** with the actual timing values shown on table **Table A-20**. All major bus signals are included in the diagram. While both a data write and data read cycle are shown, only one or the other would occur on a particular bus cycle.

### A.8.1 General Muxed Bus Timing

The expanded bus timings are highly dependent on the load conditions. The timing parameters shown assume a balanced load across all outputs.



**Figure A-9 General External Bus Timing**

**Table A-20 Expanded Bus Timing Characteristics**

Conditions are shown in **Table A-4** unless otherwise noted,  $C_{LOAD} = 50pF$

Num	C	Rating	Symbol	Min	Typ	Max	Unit
1	P	Frequency of operation (E-clock)	$f_o$	0		25.0	MHz
2	P	Cycle time	$t_{cyc}$	40			ns
3	D	Pulse width, E low	$PW_{EL}$	19			ns
4	D	Pulse width, E high <sup>1</sup>	$PW_{EH}$	19			ns
5	D	Address delay time	$t_{AD}$			8	ns
6	D	Address valid time to E rise ( $PW_{EL}-t_{AD}$ )	$t_{AV}$	11			ns
7	D	Muxed address hold time	$t_{MAH}$	2			ns
8	D	Address hold to data valid	$t_{AHDS}$	7			ns
9	D	Data hold to address	$t_{DHA}$	2			ns
10	D	Read data setup time	$t_{DSR}$	13			ns
11	D	Read data hold time	$t_{DHR}$	0			ns
12	D	Write data delay time	$t_{DDW}$			7	ns
13	D	Write data hold time	$t_{DHW}$	2			ns
14	D	Write data setup time <sup>(1)</sup> ( $PW_{EH}-t_{DDW}$ )	$t_{DSW}$	12			ns
15	D	Address access time <sup>(1)</sup> ( $t_{cyc}-t_{AD}-t_{DSR}$ )	$t_{ACCA}$	19			ns
16	D	E high access time <sup>(1)</sup> ( $PW_{EH}-t_{DSR}$ )	$t_{ACCE}$	6			ns
17	D	Non-multiplexed address delay time	$t_{NAD}$			6	ns
18	D	Non-muxed address valid to E rise ( $PW_{EL}-t_{NAD}$ )	$t_{NAV}$	15			ns
19	D	Non-multiplexed address hold time	$t_{NAH}$	2			ns
20	D	Chip select delay time	$t_{CSD}$			16	ns
21	D	Chip select access time <sup>(1)</sup> ( $t_{cyc}-t_{CSD}-t_{DSR}$ )	$t_{ACCS}$	11			ns
22	D	Chip select hold time	$t_{CSH}$	2			ns
23	D	Chip select negated time	$t_{CSN}$	8			ns
24	D	Read/write delay time	$t_{RWD}$			7	ns
25	D	Read/write valid time to E rise ( $PW_{EL}-t_{RWD}$ )	$t_{RWV}$	14			ns
26	D	Read/write hold time	$t_{RWH}$	2			ns
27	D	Low strobe delay time	$t_{LSD}$			7	ns
28	D	Low strobe valid time to E rise ( $PW_{EL}-t_{LSD}$ )	$t_{LSV}$	14			ns
29	D	Low strobe hold time	$t_{LSH}$	2			ns
30	D	NOACC strobe delay time	$t_{NOD}$			7	ns
31	D	NOACC valid time to E rise ( $PW_{EL}-t_{NOD}$ )	$t_{NOV}$	14			ns

### B.3 80-pin QFP package

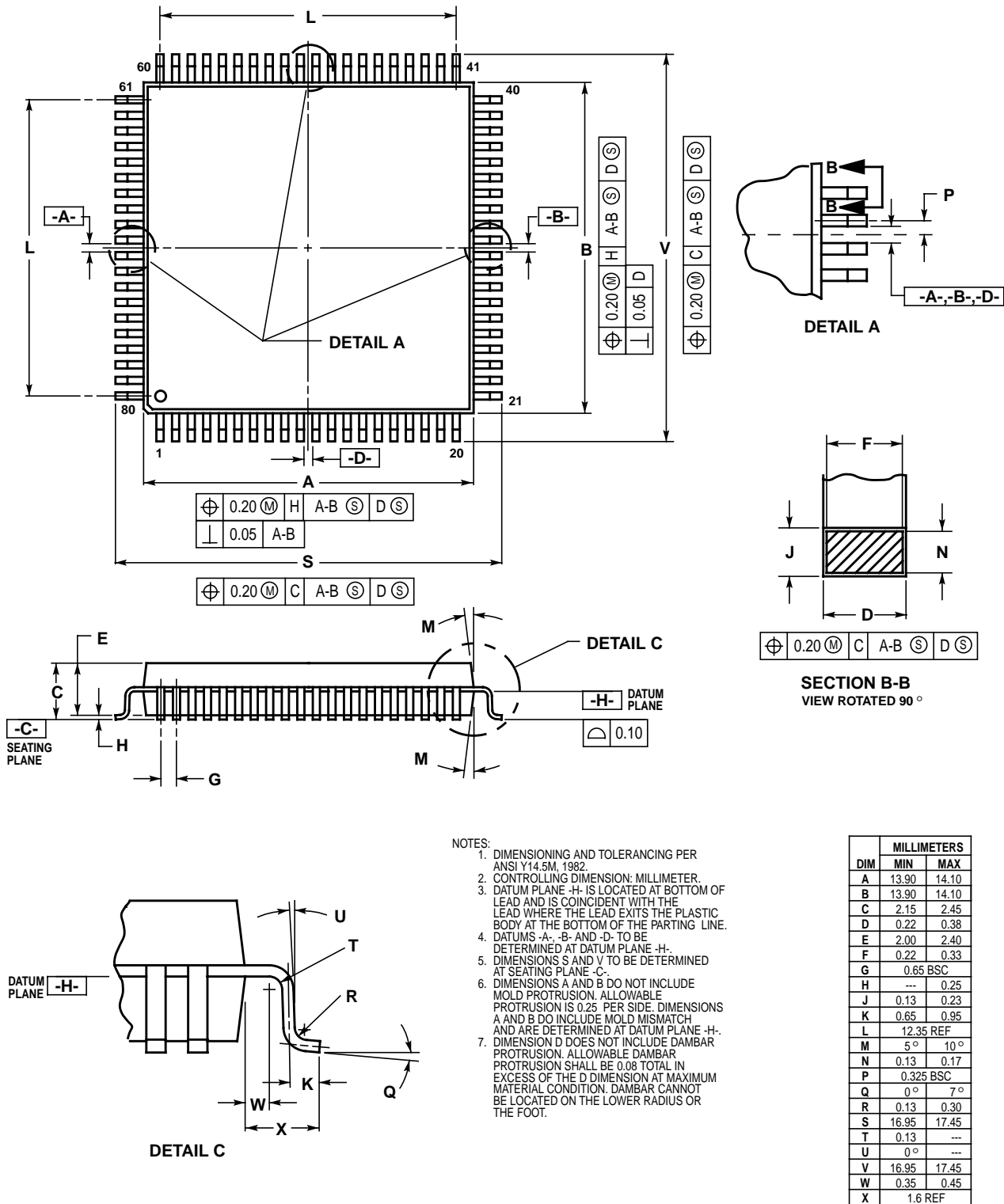


Figure 1 80-pin QFP Mechanical Dimensions (case no. 841B)